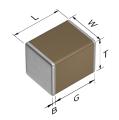


Multilayer Ceramic Chip Capacitors

C3225X8L1C156M200AC

Product Status	Production		
TDK Item Description	C3225X8L1C156MT****		
Applications	Commercial Grade Please refer to Part No. <u>CGA6M1X8L1C156M200AC</u> for Automotive use.		
Feature	150°CHigh Temperature Application		
Series	C3225 [EIA 1210]		
Brand	TDK		
Environmental Compliance	ROHS REACH Halogen Free Lead Free		



	Size
Length(L)	3.20mm ±0.40mm
Width(W)	2.50mm ±0.30mm
Thickness(T)	2.00mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	2.00mm to 2.40mm
Recommended Land Pattern (PB)	1.00mm to 1.20mm
Recommended Land Pattern (PC)	1.90mm to 2.50mm

Electrical Characteristics		
Capacitance	15μF ±20%	
Rated Voltage	16VDC	
Temperature Characteristic	X8L(+15,-40%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	6ΜΩ	

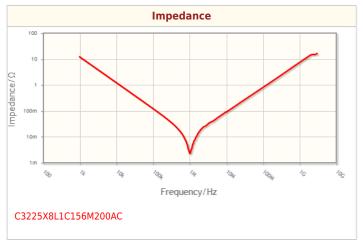
	Other
Operating Temp. Range	-55 to 150°C
Soldering Method	Reflow
AEC-Q200	NO
Packing	Embossed (Plastic)Taping [180mm Reel]
Package Quantity	1000pcs

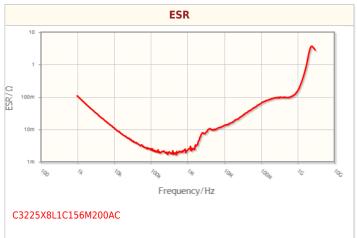
[!] Images are for reference only and show exemplary products.

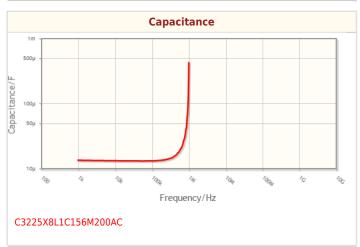
[!] This PDF document was created based on the data listed on the TDK Corporation website. ! All specifications are subject to change without notice.

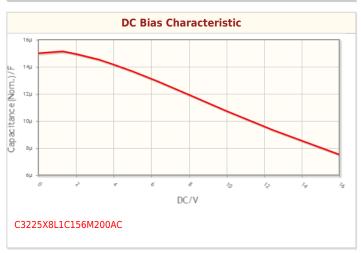
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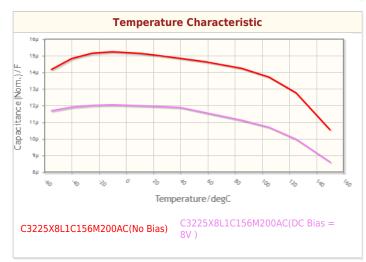
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

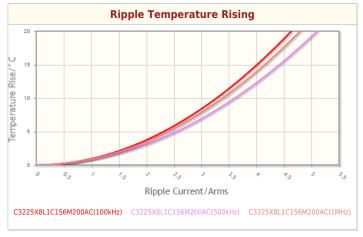












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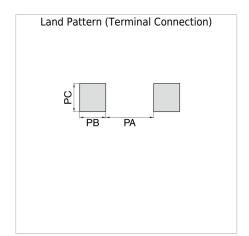
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Multilayer Ceramic Chip Capacitors

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Associated Images



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